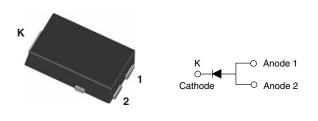
Vishay Semiconductors





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TO-277A (SMPC)

| PRODUCT SUMMARY | | | | | |
|----------------------------------|----------------|--|--|--|--|
| Package | TO-277A (SMPC) | | | | |
| I _{F(AV)} | 4 A | | | | |
| V _R | 100 V | | | | |
| V _F at I _F | 0.73 V | | | | |
| t _{rr (typ.)} | 27 ns | | | | |
| T _J max. | 175 °C | | | | |
| Diode variation | Single die | | | | |

FEATURES

- Hyperfast recovery time, reduced Q_{rr}, and soft recovery
- 175 °C maximum operating junction temperature
- Specified for output and snubber operation
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in snubber, boost, lighting, piezo-injection, as high frequency rectifiers and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

| ABSOLUTE MAXIMUM RATINGS | | | | |
|---------------------------------------------|-----------------------------------|--------------------------|-------------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Peak repetitive reverse voltage | V _{RRM} | | 100 | V |
| Average rectified forward current | I _{F(AV)} | T _{Sp} = 165 °C | 4 | А |
| Non-repetitive peak surge current | I _{FSM} | T _J = 25 °C | 130 | A |
| Operating junction and storage temperatures | T _J , T _{Stg} | | -65 to +175 | °C |

| ELECTRICAL SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$ unless otherwise specified) | | | | | | |
|---------------------------------------------------------------------------------------|-------------------------------------|--------------------------------------------------|-----|------|-------|----|
| PARAMETER | SYMBOL | IBOL TEST CONDITIONS MIN. TYP. M | | MAX. | UNITS | |
| Breakdown voltage, blocking voltage | V _{BR} , V _R | I _R = 100 μA | 100 | - | - | N |
| Forward voltage | V | I _F = 4 A | - | 0.86 | 0.93 | V |
| Forward voltage | rd voltage V _F | | - | 0.73 | 0.79 | |
| | 1 | V _R = V _R rated | - | - | 2 | |
| Reverse leakage current I _R | | $T_J = 125 \ ^{\circ}C, V_R = V_R \text{ rated}$ | - | 1 | 10 | μA |
| Junction capacitance | CT | V _R = 100 V | - | 24 | - | pF |

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RoHS COMPLIANT HALOGEN

FREE



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| DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified) | | | | | | | | |
|-------------------------------------------------------------------------------------|--------|------------------------------------------------------------------------|----------------------------------------------------------|------|------|-------|----|--|
| PARAMETER | SYMBOL | TEST CO | MIN. | TYP. | MAX. | UNITS | | |
| | | | Α/μs, V _R = 30 V | - | 27 | - | | |
| Poweree receivery time | + | I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A | | - | - | 25 | | |
| Reverse recovery time t _{rr} | ۲r | T _J = 25 °C | | - | 20 | - | ns | |
| | | T _J = 125 °C | $I_F = 4 A$ | - | 31 | - | | |
| Deck receiver aurrent | | T _J = 25 °C | | - | 2.2 | - | А | |
| Peak recovery current I _{RRM} | IRRM | T _J = 125 °C | dl _F /dt = 200 A/µs V _B = 160 V | - | 4.4 | - | A | |
| Reverse recovery charge Q _{rr} | 0 | T _J = 25 °C | | - | 22 | - | nC | |
| | Qrr | T _J = 125 °C | | - | 70 | - | | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|------------------------------------------------|-----------------------------------|---------------------------|------|--------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -65 | - | 175 | °C |
| Thermal resistance, junction to solder pad | R _{thJ-Sp} | | - | 2.2 | 3 | °C/W |
| Approximate weight | | | | 0.1 | | g |
| Approximate weight | | | | 0.0035 | | oz. |
| Marking device | | Case style TO-277A (SMPC) | | JE | H1 | |



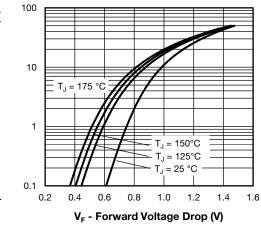


Fig. 1 - Typical Forward Voltage Drop Characteristics

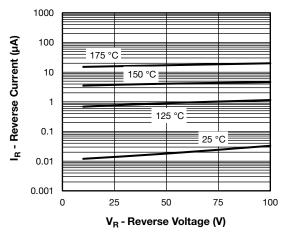
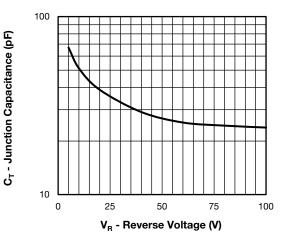


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



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Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

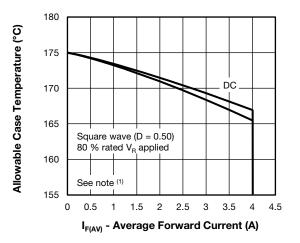
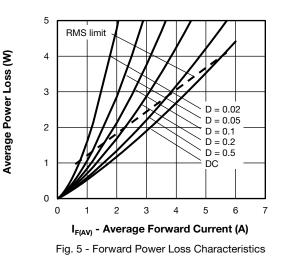


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current



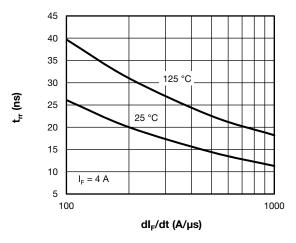


Fig. 6 - Typical Reverse Recovery Time vs. dl_F/dt

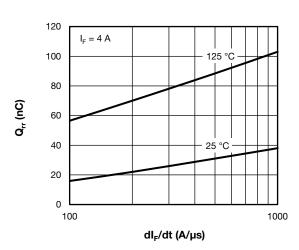


Fig. 7 - Typical Stored Charge vs. dl_F/dt

Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;

 $\begin{array}{l} \mathsf{Pd} = \mathsf{forward} \ \mathsf{power} \ \mathsf{loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \times \mathsf{V}_{\mathsf{FM}} \ \mathsf{at} \ (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \ (\mathsf{see} \ \mathsf{fig.} \ \mathsf{5}); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{inverse} \ \mathsf{power} \ \mathsf{loss} = \mathsf{V}_{\mathsf{R1}} \times \mathsf{I}_{\mathsf{R}} \ (\mathsf{1} - \mathsf{D}); \ \mathsf{I}_{\mathsf{R}} \ \mathsf{at} \ \mathsf{V}_{\mathsf{R1}} = \mathsf{rated} \ \mathsf{V}_{\mathsf{R}} \end{array}$

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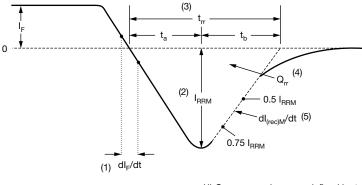
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VS-4ESH01HM3

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- (1) dl_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.

(4) ${\rm Q}_{\rm rr}$ - area under curve defined by ${\rm t}_{\rm rr}$ and ${\rm I}_{\rm RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 8 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE

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| Device code | VS- | 4 | Е | S | Н | 01 | Н | М3 |
|-------------|---------------------------------|---------------------------|-----------------------------------------|-----------------------------------------------------------------|---------------------------|---------|---------|---------|
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |
| | 1 - 2 - 3 - | Cur Circ E = | rent ratii cuit conf single c | | 4 A) 1: | oduct | | |
| | 4 - 5 - 6 - 7 - 8 - | Pro H = Volt H = | cess typ hyperfa age coo AEC-Q | package be, list recov de (01 = 101 qua en-free, | very 100 V) Ilified | complia | nt, and | termina |

| ORDERING INFORMATION (Example) | | | | | | | |
|--------------------------------|-------------------|------------------------|------------------------------------|--|--|--|--|
| PREFERRED P/N | QUANTITY PER REEL | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION | | | | |
| VS-4ESH01HM3/86A | 1500 | 1500 | 7" diameter plastic tape and reel | | | | |
| VS-4ESH01HM3/87A | 6500 | 6500 | 13" diameter plastic tape and reel | | | | |

| LINKS TO RELATED DOCUMENTS | | | | | |
|-------------------------------------|--------------------------|--|--|--|--|
| Dimensions www.vishay.com/doc?95570 | | | | | |
| Part marking information | www.vishay.com/doc?95565 | | | | |
| Packaging information | www.vishay.com/doc?88869 | | | | |

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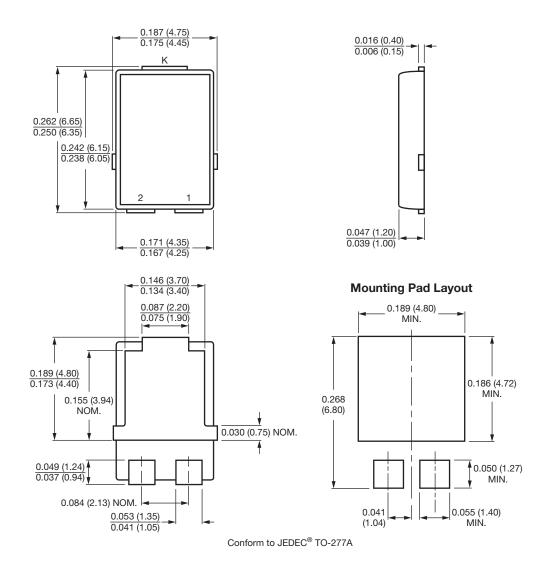
Outline Dimensions





TO-277A (SMPC)

DIMENSIONS in inches (millimeters)





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